Please amend the paragraphs at page 8, line 23 – page 9, line 12 with the

following amended paragraphs:

Fig. 4 is a stereographic diagram viewing from the inner surface 1402

of the lower metal shell 14 of Fig.1. The lower metal shell 14 has several

stakes 32 and a bent extension 24 34, and the surface 1402 is covered with

an insulator film for insulation, preferably a polytetrafluoroethylene

material such as Teflon.

Fig. 5 is a stereographic diagram viewing from the lower half case

24 of Fig. 1. The inner surface 1402 of the lower metal shell 14 is coated

with an insulator film. The plastic frame 18 has I/O portion 20, and

injection molding technique is used to embed the bent extension 24 34 into

the I/O portion 20, with the plastic frame 18 embedding the stake 28 32.

I/O portion 20 has a plastic frame 2002 and holes 2004 to expose the

copper of the transmission ports of the printer circuit board inside the small

memory card 10.

Please amend the paragraph at page 11, line 25 – page 12, line 7 with the

following amended paragraph:

Fig. 14 is to cut the connection bars 34 108 and 36 110 between the

metal shell 12 and metal belt 100 by stamping to release the upper half case

Page 2 of 12

MR3325-8

Serial Number: 10/657,122

Reply to Office Action dated 3 June 2005

22 from the metal belt 100 and at the same time to form the recesses 26 and

28. This step is to unload the semi-finished products. The lower half-case

24 is formed by the same process as in the aforementioned description. In

the last step 208 is sonic welding the upper and lower half cases 22 and 24

together to form the small memory card 10.